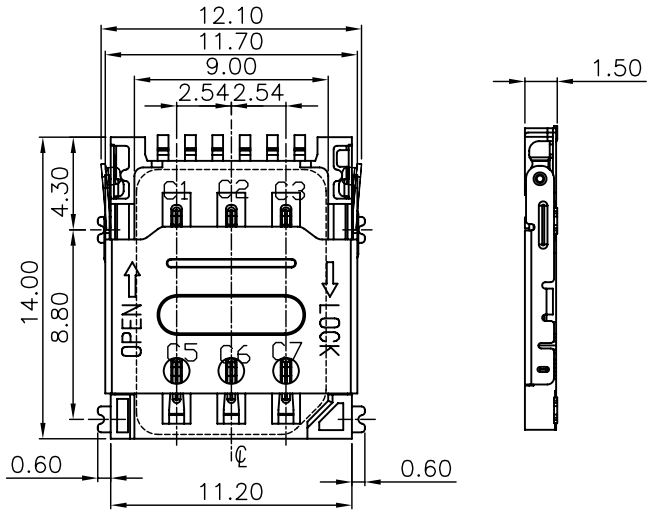
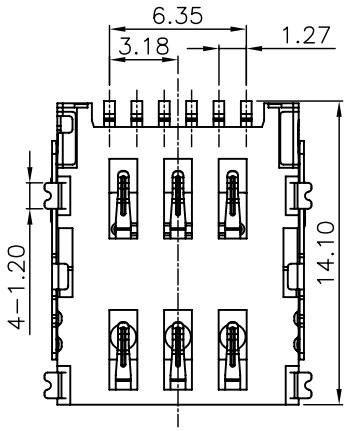
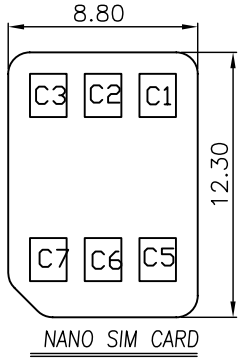
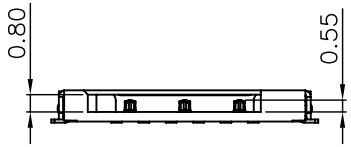
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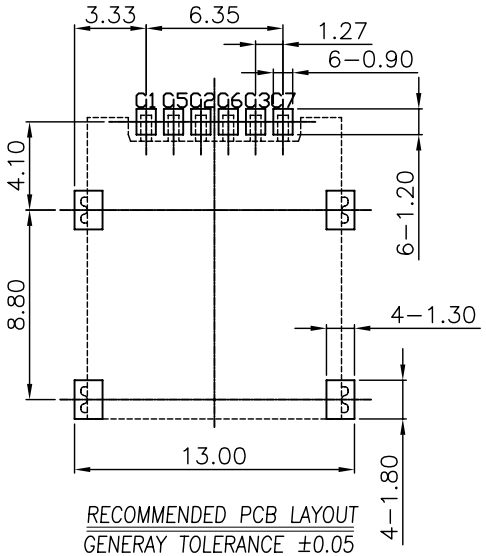




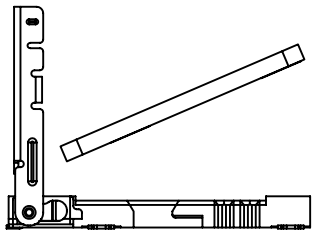


SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

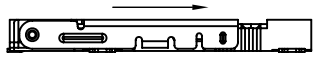




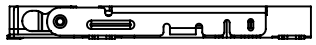
RECOMMENDED PCB LAYOUT
GENERAY TOLERANCE ±0.05



STEP 1 INSERT Micro-SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
SHELL: SUS

PLATING:

Contact: Plated 50u" Ni Overall Contact ALL Au 1U,
Shell: ALL NI 30U/MIN

Electrical:

Current Rating : 0.5mA AC/DC max.
Voltage Rating : 125V AC/DC
Ambient Temperature Range : -20℃~+60℃
Storage Temperature Range : -40℃~+70℃
Ambient Humidity Range : 95% R.H. Max.
Contact Resistance: 80mΩ max.
Insulation Resistance: 100MΩ min./100V DC
Mating Cycles: 5,000 Insertions
Reflow peak temp.: 260℃ ±5℃, 3~5 S

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME: NANO SIM 6P 掀盖1.5H
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC240-SIM06-150
			MOLD NO.
UNIT: mm [inch]	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HYC-SIM191128102
SCALE:1:1 SIZE: A4			SHEET NO. 1 OF 1